European Space Components Coordination

Pages 1 to 16

TRANSISTORS, LOW POWER, PNP

BASED ON TYPE 2N2894 and 2N2894A

ESCC Detail Specification No. 5202/004

as applicable

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as applicable

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DCR No.	CHANGE DESCRIPTION
~~442, 455~~	Specification up issued to incorporate editorial and technical changes per DCR.

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1. GENERAL

1.1 SCOPE

This specification details the ratings, physical and electrical characteristics and test and inspection data for the component type variants and/or the range of components specified below. It supplements the requirements of, and shall be read in conjunction with, the ESCC Generic Specification listed under Applicable Documents.

1.2 APPLICABLE DOCUMENTS

The following documents form part of this specification and shall be read in conjunction with it:

(a) ESCC Generic Specification No. 5000
(b) MIL-STD-750, Test Methods and Procedures for Semiconductor Devices

1.3 TERMS, DEFINITIONS, ABBREVIATIONS, SYMBOLS AND UNITS

For the purpose of this specification, the terms, definitions, abbreviations, symbols and units specified in ESCC Basic Specification No. 21300 shall apply.

1.4 THE ESCC COMPONENT NUMBER AND COMPONENT TYPE VARIANTS

1.4.1 The ESCC Component Number

The ESCC Component Number shall be constituted as follows:

Example: 520200401

- Detail Specification Reference: 5202004
- Component Type Variant Number: 01 (as required)

1.4.2 Component Type Variants

The component type variants applicable to this specification are as follows:

Variant Number	Based on Type	Case	Lead/Terminal Material and/or Finish	Weight max g
01	2N2894	TO-18	D2	0.4
02	2N2894A	TO-18	D2	0.4
03	2N2894	TO-18	D3 or D4	0.4
04	2N2894A	TO-18	D3 or D4	0.4
05	2N2894	TO-18	D7	0.4
06	2N2894	CCP	2	0.06
07	2N2894	CCP	4	0.06

The lead/terminal material and/or finish shall be in accordance with the requirements of ESCC Basic Specification No. 23500.

1.5 MAXIMUM RATINGS

The maximum ratings shall not be exceeded at any time during use or storage.

Maximum ratings shall only be exceeded during testing to the extent specified in this specification and when stipulated in Test Methods and Procedures of the ESCC Generic Specification.

Characteristics	Symbols	Maximum Ratings	Unit	Remarks
Collector-Base Voltage	V_{CBO}	-12	V	Over entire operating temperature range
Collector-Emitter Voltage	V_{CEO}	-12	V	
Emitter-Base Voltage	V_{EBO}	-4	V	
Collector Current	I_C	-200	mA	Continuous
Power Dissipation For TO-18 and CCP	P_{tot1}	0.36	W	At $T_{amb} \leq +25^oC$ ~~Note 1~~
~~For CCP~~	~~P_{tot2}~~	~~0.58 (Note 2)~~	~~W~~	
For TO-18	P_{tot2}	1.2	W	At $T_{case} \leq +25^oC$ ~~Note 1~~
Operating Temperature Range	T_{op}	-65 to +200	°C	Note 2
Storage Temperature Range	T_{stg}	-65 to +200	°C	Note 2
Soldering Temperature For TO-18 For CCP	T_{sol}	 +260 +245	°C	 Note 3 Note 4

NOTES:

~~1. For T_{amb} or $T_{case} > +25^oC$, derate linearly to 0W at $+200^oC$.~~

~~2. When mounted on a 15 x 15 x 0.6mm ceramic substrate.~~

2. For Variants with tin-lead plating or hot solder dip lead finish all testing, and any handling, performed at $T_{amb} > +125^oC$ shall be carried out in a 100% inert atmosphere.

3. Duration 10 seconds maximum at a distance of not less than 1.5mm from the device body and the same lead shall not be resoldered until 3 minutes have elapsed.

4. Duration 5 seconds maximum and the same terminal shall not be resoldered until 3 minutes have elapsed.

Thermal Resistance, Junction-to-Ambient	$R_{th(j-a)}$	486	°C/W	
Thermal Resistance, Junction-to-Case	$R_{th(j-c)}$	145.8	°C/W	Note 1

1. Thermal Resistance, Junction-to-Case only applies to TO-18 packaged Variants.

Need Thermal Resistance, Junction-to-Soldering Point for Variants 06 and 07 ?

Characteristics	Symbols	MIL-STD-750 Test Method	Test Conditions	Limits		Units
				Min	Max	
Base-Emitter Saturation Voltage	$V_{BE(sat)1}$	3066	I_C=-10mA I_B=-1mA Note 1 Test condition A 2N2894 2N2894A	 -780 -	 -980 -	mV
	$V_{BE(sat)2}$	3066	I_C=-30mA I_B=-3mA Note 1 Test condition A 2N2894 2N2894A	 -0.85 -	 -1.2 -1.15	V
Magnitude of Small-Signal Short-Circuit Forward-Current Transfer Ratio	$\|h_{fe}\|$	3306	V_{CB}=-30mA, V_{CE}=-10V f=100MHz Note 2 2N2984 2N2894A	 4 7	 - -	-
Output Capacitance	C_{obo}	3236	V_{CB}=-5V, I_E=0A f=1MHz Note 2 2N2984 2N2894A	 - -	 6 4.5	pF
Input Capacitance	C_{ibo}	3240	V_{EB}=-500mV I_C=0A f=1MHz Note 2	-	6	pF
Turn-on Time	t_{on}	-	V_{BB}=3V, V_{IN}=-7V, I_C=-30mA I_{BL}=1.5mA Notes 2, 3 2N2984 2N2894A	 - -	 60 40	ns
Turn-off Time	t_{off}	-	V_{BB}=-4V, V_{IN}=6V, I_C=-30mA I_{B1}=I_{B2}=1.5mA Notes 2, 3 2N2984 2N2894A	 - -	 90 60	ns

NOTES:

1. Pulse measurement: Pulse Width ≤ 300µs, Duty Cycle ≤ 2% .
2. For AC characteristics read and record measurements shall be performed on a sample of 32 components with 0 failures allowed. Alternatively a 100% inspection may be performed.
3. t_{on} shall be measured using the following test circuit. The input waveform shall be supplied by a pulse generator with the following characteristics: Z_{OUT} = 50Ω, t_r ≤ 2ns, Pulse Width = 200 ±10ns, Duty Cycle ≤ 2%. The output waveform shall be monitored on an oscilloscope with the following

2.4.2 High and Low Temperatures Electrical Measurements

Characteristics	Symbols	MIL-STD-750 Test Method	Test Conditions Note 1	Limits		Units
				Min	Max	
Collector-Base Cut-off Current	I_{CBO}	3036	T_{amb}=+150 (+0 -5)°C V_{CB}=-50V Bias condition D	-	-10	µA
Forward-Current Transfer Ratio 2	h_{FE2}	3076 correct font	T_{amb}=-55 (+5 -0)°C V_{CE}=-500mV I_C=-30mA Note 2	20	-	-

NOTES:

1. Read and record measurements shall be performed on a sample of 5 components with 0 failures allowed. Alternatively a 100% inspection may be performed.
2. Pulsed measurement: Pulse Width ≤300µs, Duty Cycle ≤2%.

upper case

2.5 PARAMETER DRIFT VALUES

Unless otherwise specified, the measurements shall be performed at T_{amb}=+22 ±3°C.

The test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements.

The drift values (Δ) shall not be exceeded for each characteristic specified. The corresponding absolute limit values for each characteristic shall not be exceeded.

Characteristics	Symbols	Limits			Units
		Drift Value Δ	Absolute		
			Min	Max	
Collector-Base Cut-off Current	I_{CBO}	±20 or (1) ±100%	-	-10	nA
Forward-Current Transfer Ratio 2 2N2894 2N2894A	h_{FE2}	±15%	 40 40	 150 150	-
Collector-Emitter Saturation Voltage 3 2N2894 2N2894A	$V_{CE(sat)}$	±50 or (1) ±15%	 - -	 -500 -450	mV

NOTES:

1. Whichever is the greater referred to initial value.

2.6 INTERMEDIATE AND END-POINT ELECTRICAL MEASUREMENTS

Unless otherwise specified, the measurements shall be performed at T_{amb}=+22 ±3°C.

The test methods and test conditions shall be as per the corresponding test defined in Room Temperature Electrical Measurements.

The limit values for each characteristic shall not be exceeded.

Characteristics	Symbols	Limits		Units
		Min	Max	
Collector-Base Cut-off Current	I_{CBO}	-	-100	nA
Forward-Current Transfer Ratio 2 2N2894 2N2894A	h_{FE2}	 40 40	 150 150	-
Collector-Emitter Saturation Voltage 3 2N2894 2N2894A	$V_{CE(sat)}$	 - -	 -500 -450	mV

2.7 HIGH TEMPERATURE REVERSE BIAS BURN-IN CONDITIONS

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T_{amb}	+150 (+0 -5)	°C
Collector-Base Voltage	V_{CB}	12	V
Duration	t	72 minimum	Hours

2.8 POWER BURN-IN CONDITIONS

Characteristics	Symbols	Test Conditions	Units
Ambient Temperature	T_{amb}	+20 to +50	°C
Power Dissipation	P_{tot}	As per Maximum Ratings. P_{tot1} ~~derated~~ at the chosen T_{amb} using the	W
Collector-Base Voltage	V_{CB}	-10	V

Derate

Specified $R_{th(j-a)}$.

2.9 OPERATING LIFE CONDITIONS

The conditions shall be as specified for Power Burn-in.